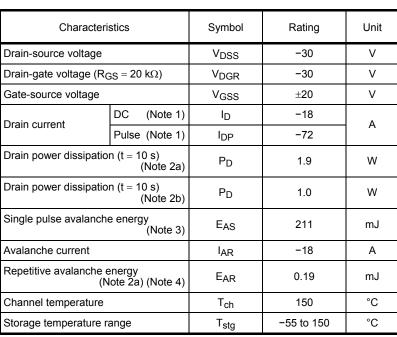
TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (U-MOSIV)

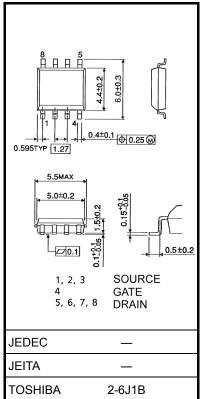
TPC8114

Lithium Ion Battery Applications Notebook PC Applications Portable Equipment Applications

- Small footprint due to small and thin package
- Low drain-source ON resistance: R_{DS} (ON) = 3.1 m Ω (typ.)
- High forward transfer admittance: $|\,Y_{\rm fs}|$ = 47 S (typ.)
- Low leakage current: $I_{DSS} = -10 \mu A (max) (V_{DS} = -30 V)$
- Enhancement mode: V_{th} = -0.8 to -2.0 V (V_{DS} = -10 V, I_D = -1 mA)

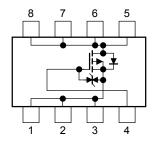


Absolute Maximum Ratings (Ta = 25°C)



Weight: 0.080 g (typ.)

Circuit Configuration



Note: (Note 1), (Note 2), (Note 3) and (Note 4): See the next page.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

This transistor is an electrostatic-sensitive device. Please handle with caution.

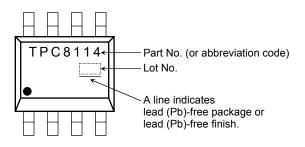
Unit: mm

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Thermal Characteristics

| Characteristics | Symbol | Max | Unit |
|--|------------------------|------|------|
| Thermal resistance, channel to ambient (t = 10 s) (Note 2a) | R _{th (ch-a)} | 65.8 | °C/W |
| Thermal resistance, channel to ambient (t = 10 s) (Note 2b) | R _{th (ch-a)} | 125 | °C/W |

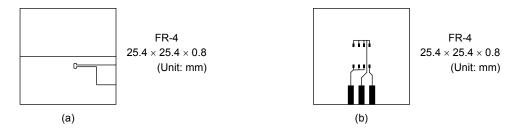
Marking (Note 5)



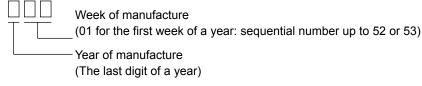
Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2:

(a) Device mounted on a glass-epoxy board (a) (b) Device mounted on a glass-epoxy board (b)



- Note 3: $V_{DD} = -24$ V, $T_{ch} = 25^{\circ}C$ (initial), L =500 μ H, R_G = 25 Ω , I_{AR} = -18 A
- Note 4: Repetitive rating; pulse width limited by maximum channel temperature
- Note 5: on lower left of the marking indicates Pin 1. % Weekly code: (Three digits)



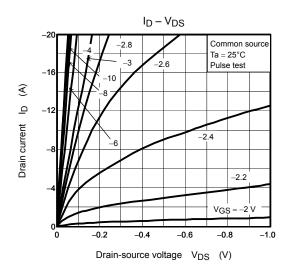
Electrical Characteristics (Ta = 25°C)

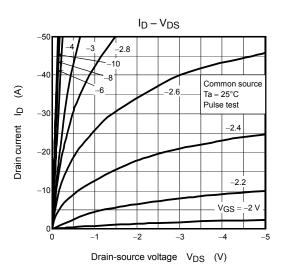
| Characteristics | | Symbol | Test Condition | Min | Тур. | Max | Unit | |
|--|---------------|----------------------|--|------|------|------|------|--|
| Gate leakage current | | I _{GSS} | $V_{GS}=\pm 16~V,~V_{DS}=0~V$ | _ | | ±10 | μA | |
| Drain cut-OFF current | | I _{DSS} | $V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | _ | | -10 | μA | |
| Drain-source breakdown voltage | | V (BR) DSS | $I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$ | -30 | _ | _ | V | |
| | | V (BR) DSX | $I_D = -10$ mA, $V_{GS} = 20$ V | -15 | | _ | v | |
| Gate threshold voltage | | V _{th} | $V_{DS} = -10 \text{ V}, \text{ I}_{D} = -1 \text{ mA}$ | -0.8 | | -2.0 | V | |
| Drain-source ON resistance | | Pro (out) | $V_{GS} = -4 \text{ V}, \text{ I}_D = -9 \text{ A}$ | _ | 5.2 | 6.8 | mΩ | |
| | | R _{DS (ON)} | $V_{GS} = -10 \text{ V}, \text{ I}_{D} = -9 \text{ A}$ | _ | 3.1 | 4.5 | | |
| Forward transfer admittance | | Y _{fs} | $V_{DS} = -10 \text{ V}, \text{ I}_{D} = -9 \text{ A}$ | 23.5 | 47 | _ | S | |
| Input capacitance | | C _{iss} | | _ | 7480 | _ | pF | |
| Reverse transfer capacitance | | C _{rss} | $V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | _ | 1320 | _ | | |
| Output capacitance | | C _{oss} | | _ | 1460 | _ | | |
| Switching time | Rise time | tr | $V_{GS} = -9 A$ O = -9 A O = | — | 25 | | - ns | |
| | Turn-ON time | t _{on} | | | 36 | | | |
| | Fall time | t _f | | _ | 235 | _ | | |
| | Turn-OFF time | t _{off} | $V_{DD} \simeq -15 \text{ V}$ Duty $\leq 1\%, t_W = 10 \ \mu s$ | _ | 625 | _ | | |
| Total gate charge (gate-source plus gate-drain) | | Qg | $V_{DD} \simeq -24 \text{ V}, \text{ V}_{GS} = -10 \text{ V},$ | | 180 | | nC | |
| Gate-source charge 1 | | Q _{gs1} | $I_{\rm D} = -18 \rm{A}$ | _ | 10 | | | |
| Gate-drain ("miller") charge | | Q _{gd} | | _ | 60 | | | |

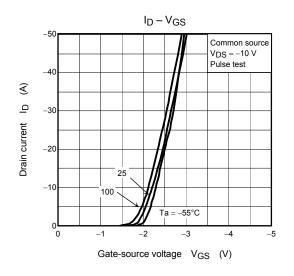
Source-Drain Ratings and Characteristics (Ta = 25°C)

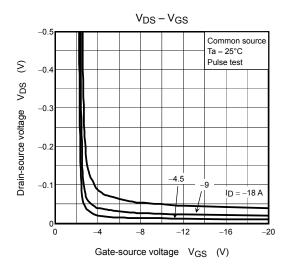
| Characteristics | | Symbol | Test Condition | Min | Тур. | Max | Unit | |
|-------------------------|-------|------------------|--|-----|------|-----|------|---|
| Drain reverse current | Pulse | (Note 1) | I _{DRP} | — | _ | _ | -72 | А |
| Forward voltage (diode) | | V _{DSF} | $I_{DR} = -18 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$ | | _ | 1.2 | V | |

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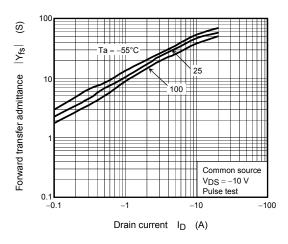




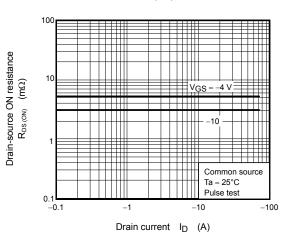




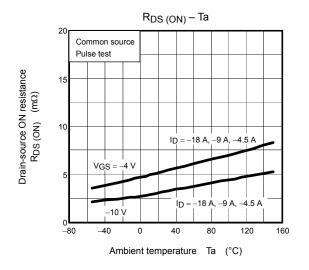


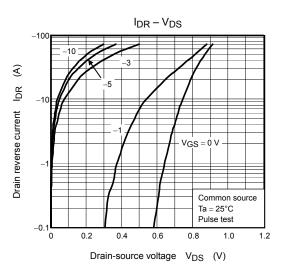


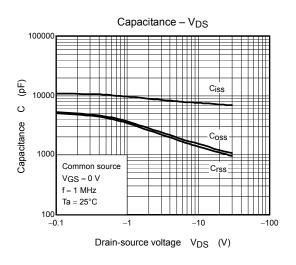
R_{DS (ON)} - I_D



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P_D – Ta

t = 10 s

120

160

200

 Device mounted on a glass-epoxy board (a) (Note 2a)

(2) Device mounted on a glass-epoxy board (b) (Note 2b)

2.0

1.6

1.2 (2)

0.8

0.4

0 0

40

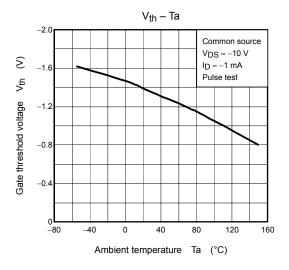
80

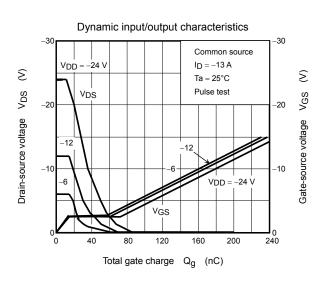
Ambient temperature Ta (°C)

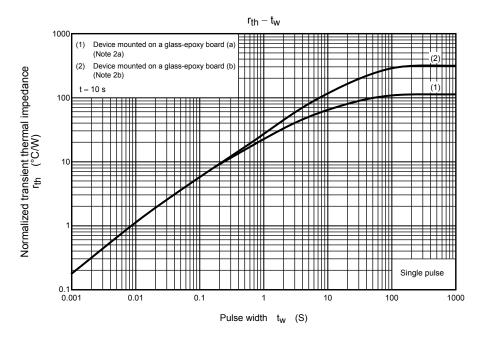
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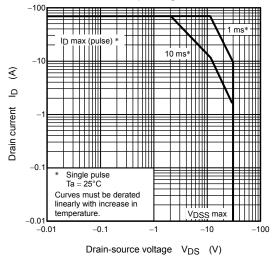
Drain power dissipation







Safe operating area



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20070701-EN

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